503176178 02/11/2015

PATENT ASSIGNMENT COVER SHEET

EPAS ID: PAT3222792

Electronic Version v1.1 Stylesheet Version v1.2

SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WON SEOK CHOI	02/02/2015
CHUL HWAN CHOI	02/02/2015
JONG HO PARK	02/02/2015

RECEIVING PARTY DATA

Name:	LSIS CO., LTD.		
Street Address: 127, LS-RO, DONGAN-GU			
City: ANYANG-SI, GYEONNGI-DO			
State/Country:	ate/Country: KOREA, REPUBLIC OF		
Postal Code:	431-848		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14620012

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 2163-3576 NAME OF SUBMITTER: JUSTIN D. LEE SIGNATURE: /Justin D. Lee/ **DATE SIGNED:** 02/11/2015

Total Attachments: 1

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PATENT REEL: 034942 FRAME: 0731 503176178

IP-14-0243_US Attorney Docket No.

ASSIGNMENT

(1-8)	1-8) Insert Name(s) of Inventor(s)		CHOI, WON SEOK	(5)	
	(2) (CHOI, CHUL HWAN	(6)		
		(3) F	ARK, JONG HO	(7)	
		(4)		(8)	
			valuable considerations	paid to each	(\$1.00) and other good and of the undersigned, the by does assign, transfer and
(9)	Insert name of Assignee	(9)	LSIS CO., LTD.		

- Insert name of Assignee
- (10) Insert state of Incorporation (10) Republic of Korea of Assignee
- (11) Insert address of Assignee

(hereinafter designated as the Assignee) the entire worldwide right, title and interest in the invention known as

127, LS-ro, Dongan-gu, Anyang-si, Gyeonggi-do, 431-848, Republic of Korea

(12) Insert identification of Invention, such as Title, Case Number or Foreign Application Number

(12) POWER SYSTEM

for which the undersigned has (have) executed an application for patent in the United States of America and all patent applications in foreign countries corresponding thereto or based thereon.

- The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.
- The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.
- The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.
- The undersigned scree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.
- The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed any agreement in conflict herewith.

The undersigned hereby appoints the Attorneys associated with Customer No. 35884 the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: <u>20/5 2 2</u>	Signature of Inventor (1) CHOL WON SEOK
	Signature of Inventor (2) CHOL CHUL HWAN
Date: <u>240/3* </u>	Signature of Inventor (3) PARK, JONG HO
Date:	Signature of Inventor (4)